

March 2013

FCP600N60Z / FCPF600N60Z N-Channel SuperFET® II MOSFET

600 V, 7.4 A, 600 mΩ

Features

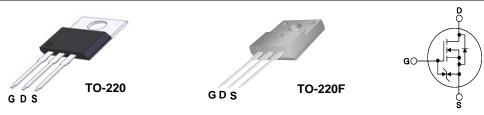
- 650 V @T_{.1} = 150°C
- Max. $R_{DS(on)} = 600 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_q = 20 nC)
- Low Effective Output Capacitance (Typ. C_{oss}.eff = 74 pF)
- 100% Avalanche Tested
- ESD Improved Capacity

Applications

- LCD / LED / PDP TV and Monitor Lighting
- · Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®]II MOSFET is Fairchild Semiconductor [®], s first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFETII MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.



MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol		Parameter		FCP600N60Z	FCPF600N60Z	Unit	
V _{DSS}	Drain to Source Voltage				600		
V	Cata to Source Voltage	- DC		±	:20	V	
V_{GSS}	Gate to Source Voltage	- AC	(f > 1 Hz)	±	:30	V	
	Drain Current	-Continuous (T _C = 25°C)		7.4	7.4*	^	
ID	Drain Current	-Continuous (T _C = 100°C)		4.7	4.7*	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	22.2	22.2*	Α	
E _{AS}	Single Pulsed Avalanche Ene	ergy	(Note 2)	2) 135		mJ	
I _{AR}	Avalanche Current		(Note 1)) 1.5		Α	
E _{AR}	Repetitive Avalanche Energy	,	(Note 1)	te 1) 0.89		mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	3) 20		V/ns	
uv/ut	MOSFET dv/dt			1	00	V/ns	
L L	Dower Dissinction	(T _C = 25°C)		89	28	W	
P_{D}	Power Dissipation	- Derate above 25°C		0.71	0.22	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to	o +150	°С		
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			00	°C		

^{*}Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter I		FCPF600N60Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	4.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	5

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCP600N60Z	FCP600N60Z	TO-220	-	-	50
FCPF600N60Z	FCPF600N60Z	TO-220F	-	-	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}, T_J = 25^{\circ}\text{C}$	600	-	-	V
	Drain to Source Breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}, T_J = 150^{\circ}\text{C}$	650	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = 10 mA, Referenced to 25°C	-	0.67	-	V/°C
BV _{DS}	Drain-Source Avalanche Breakdown Voltage	V _{GS} = 0 V, I _D = 7.4 A	-	700	-	V
	Zero Gate Voltage Drain Current	V _{DS} = 480 V, V _{GS} = 0 V	-	-	1	
IDSS	Zero Gate voltage Drain Current	$V_{DS} = 480 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	10	μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±10	uA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.5	-	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 3.7 \text{ A}$	•	0.51	0.6	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, I_{D} = 3.7 \text{ A}$	ı	6.7		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 05 V V 0 V	-	840	1120	pF
C _{oss}	Output Capacitance	V _{DS} = 25 V, V _{GS} = 0 V f = 1 MHz		630	840	pF
C _{rss}	Reverse Transfer Capacitance			30	45	pF
C _{oss}	Output Capacitance	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$	-	16.5	-	pF
Coss eff.	Effective Output Capacitance	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$	-	74	-	pF
Q _{g(tot)}	Total Gate Charge at 10V		-	20	26	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DS} = 380 \text{ V}, I_{D} = 3.7 \text{ A}$	-	3.4	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	V _{GS} = 10 V (Note 4)	-	7.5	-	nC
ESR	Equivalent Series Resistance	Drain open	-	2.89	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	13	36	ns
t _r		$V_{DD} = 380 \text{ V}, I_D = 3.7 \text{ A}$	-	7	24	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$	-	39	88	ns
t _f	Turn-Off Fall Time	(Note 4)	-	9	28	ns

Drain-Source Diode Characteristics

IS	Maximum Continuous Drain to Source Diode Forward Current		-	1	7.4	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	22.2	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 3.7 \text{ A}$	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 3.7 A	-	200	-	ns
Q_{rr}	Reverse Recovery Charge $dI_F/dt = 100 \text{ A/}\mu\text{s}$		-	2.3	-	μC

Notes:

- ${\bf 1.}\ {\bf Repetitive}\ {\bf Rating:}\ {\bf Pulse}\ {\bf width}\ {\bf limited}\ {\bf by}\ {\bf maximum}\ {\bf junction}\ {\bf temperature}$
- 2. I_{AS} = 1.5 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C
- 3. $I_{SD} \le 3.7$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$
- 4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

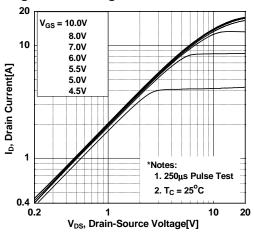


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

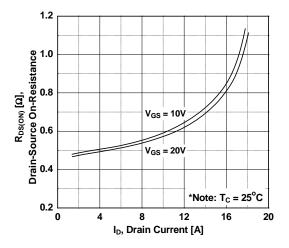


Figure 5. Capacitance Characteristics

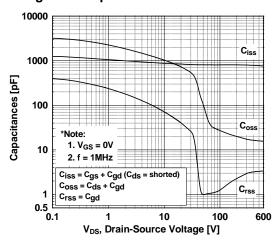


Figure 2. Transfer Characteristics

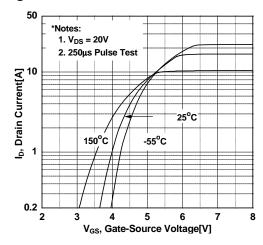


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

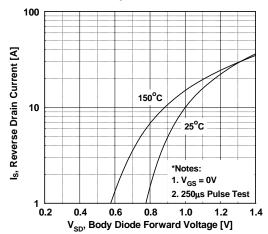
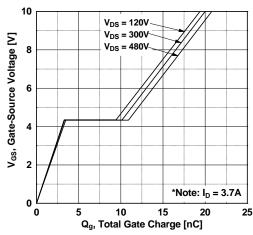


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

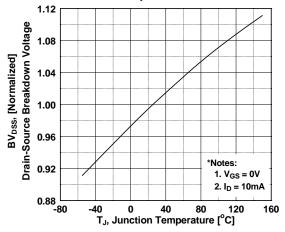


Figure 9. Maximum Safe Operating Area vs. Case Temperature - FCP600N60Z

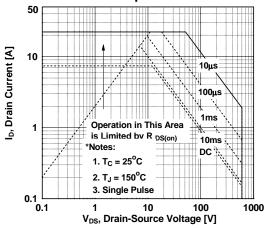


Figure 11. Maximum Drain Current

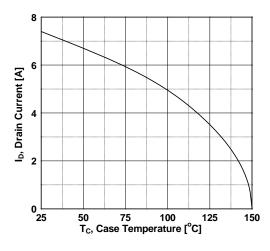


Figure 8. On-Resistance Variation vs. Temperature

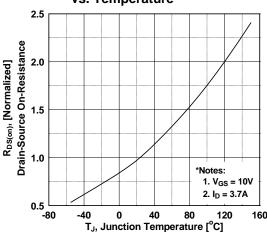


Figure 10. Maximum Safe Operating Area vs. Case Temperature - FCPF600N60Z

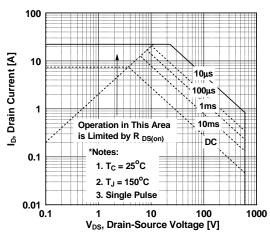
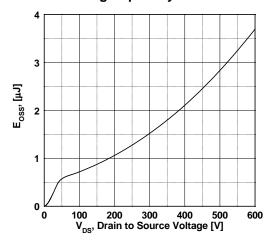


Figure 12. Eoss vs. Drain to Source Voltage Switching Capability



Typical Performance Characteristics (Continued)

Figure 13. Transient Thermal Response Curve - FCP600N60Z

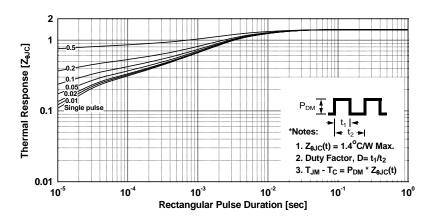
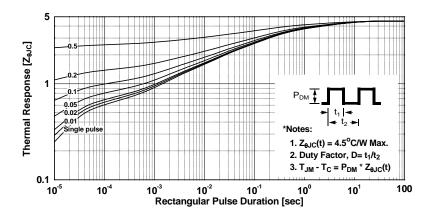
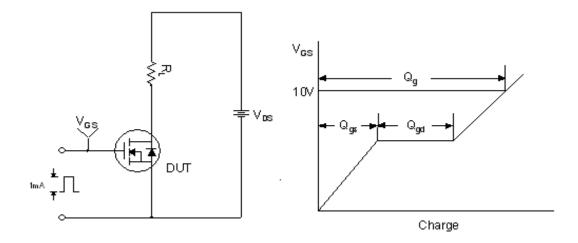


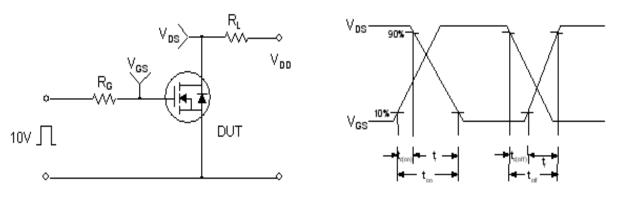
Figure 14. Transient Thermal Response Curve - FCPF600N60Z



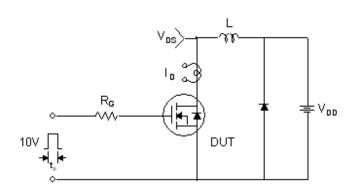
Gate Charge Test Circuit & Waveform

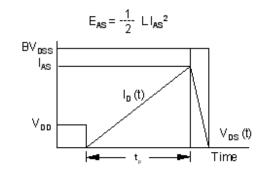


Resistive Switching Test Circuit & Waveforms

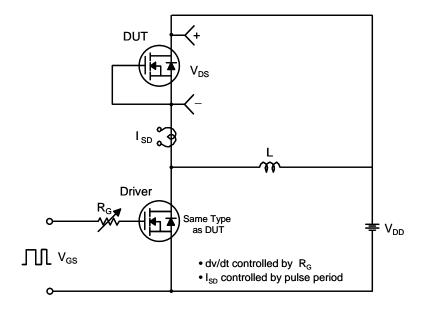


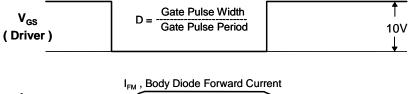
Unclamped Inductive Switching Test Circuit & Waveforms

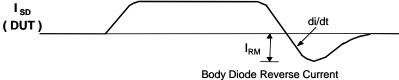


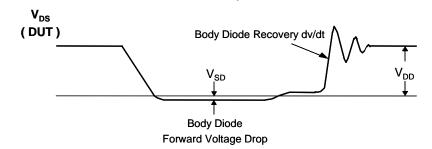


Peak Diode Recovery dv/dt Test Circuit & Waveforms



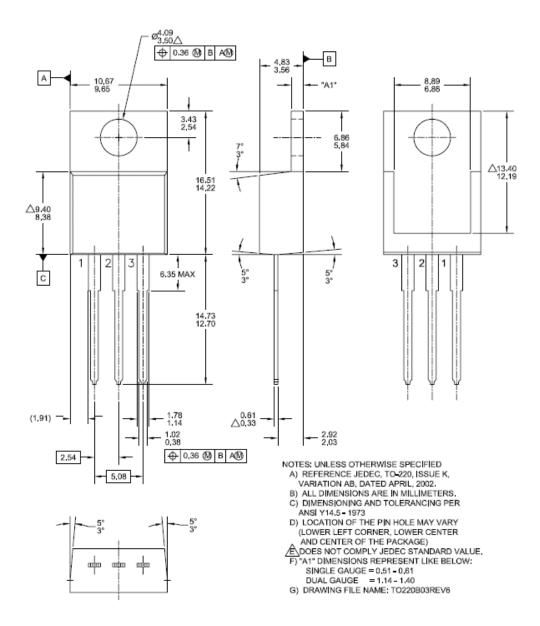






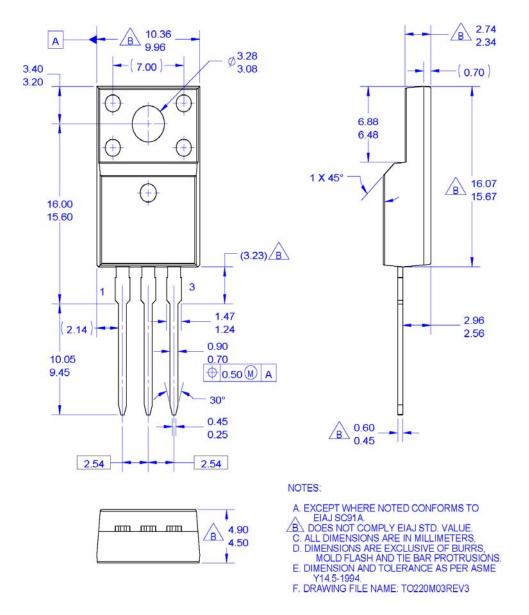
Mechanical Dimensions

TO-220AB



Package Dimensions

TO-220F (Retractable)



* Front/Back Side Isolation Voltage: AC 2500V

Dimensions in Millimeters





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